



UWB 5G Package-Integrated Antenna Array Design

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Outline



- Goals & Objectives
- Prior Work
- Technical Approach
- Results & Key Accomplishments
- Comparison with Prior Art
- Schedule
- Summary



Goals and Objectives

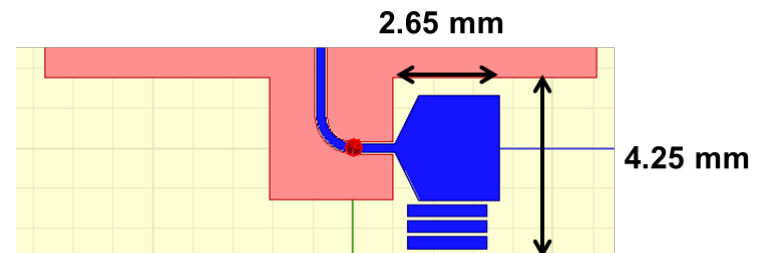
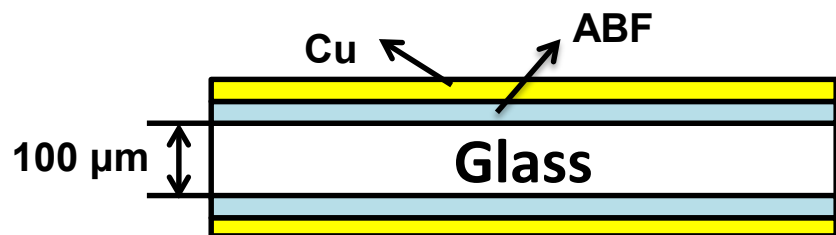
- Modeling and Designing ultra wideband (UWB) Yagi and Horn antenna on thin glass substrates for 5G mm-wave communications.
- Using the designed antennas and phase arrays to implement UWB and high gain antenna arrays.
- Integrating the designed antennas with precision RDL and interconnections to form a fully-functional D&D test vehicles

	Objectives	Prior Art	Challenges	Tasks
Performance (Yagi)	<ul style="list-style-type: none"> • RL > 10dB • Gain \approx 4 dBi • FBW > 49 % • 24.25 - 40 GHz • Size < $\lambda/2$ 	<ul style="list-style-type: none"> • FBW<20% 	<ul style="list-style-type: none"> • UWB matching circuit and balun • UWB radiator 	<ul style="list-style-type: none"> • Task1: UWB matching circuit design • Task2: UWB balun design • Task3: UWB radiator design • Task4: Optimize antenna design
Performance (Horn)	<ul style="list-style-type: none"> • RL > 10dB • Gain \approx 4 dBi • FBW > 49 % • 24.25 - 40 GHz • Size: As small as possible 	<ul style="list-style-type: none"> • FBW<20% 	<ul style="list-style-type: none"> • Thin substrate for horn antenna • Broadband design • Size reduction 	<ul style="list-style-type: none"> • Task1: Glass properties effects on the antenna performance • Task2: Embedding cavity design • Task3: Planar corrugated horn structure design • Task4: Broadband Horn to Air Transition Design • Task5: Stack the horn design with the Yagi design to get dual-polarization antennas
Performance (Array)	<ul style="list-style-type: none"> • RL > 10dB • FBW > 55 % • Phased array design 	<ul style="list-style-type: none"> • FBW<20% • Not phased array 	<ul style="list-style-type: none"> • Precise phase shift for the phase array and feed line • Broadband phase array 	<ul style="list-style-type: none"> • Broadband phase array design

Prior Work

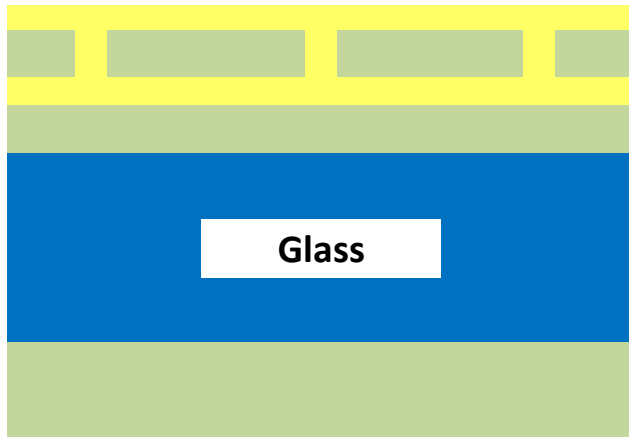


- ❑ 100 μm ultra-thin glass package
- ❑ Monopole radiator to achieve UWB
- ❑ Miniaturization by removing balun and matching circuit
- ❑ 24 – 43.5 GHz, FBW > 57.8 %
- ❑ $S_{11} < -10$ dB
- ❑ Realized gain > 4 dBi
- ❑ Size: $0.22 \lambda_0 \times 0.35 \lambda_0$





Technical Approach



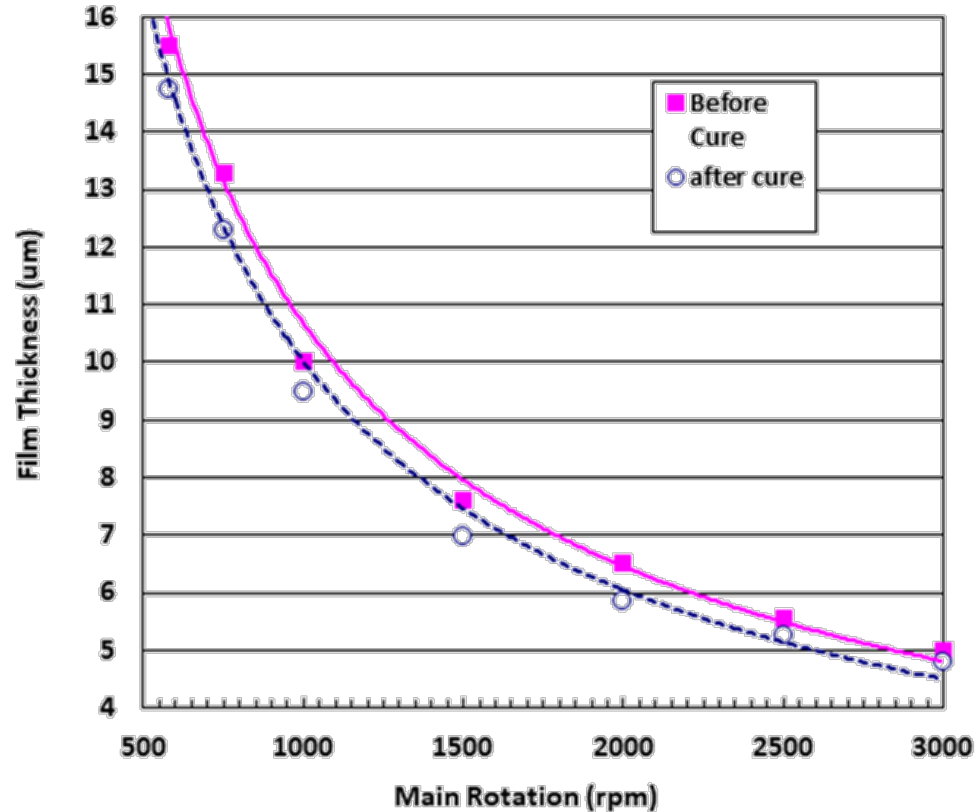
Layer	Details
M1 (Top)	Microstrip Passive Components (5-8 μm)
Dielectric-1	JSR (15 μm)
M2	GND, Dicing Clearance (5-8 μm)
Dielectric-2	JSR (15 μm)
Core-Glass	AGC EN-A1 (100 μm)
Dielectric-3	JSR (15 μm)
Dielectric-4 (Bottom)	JSR (15 μm)



Technical Approach

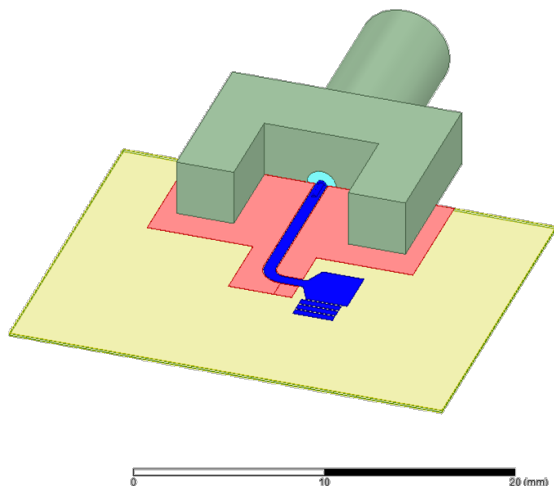
- ❑ JSR materials to reduce warpage
- ❑ Precise thickness control to reduce variations
- ❑ Include end launch connector into simulation

	JSR Material	ABF
Young's Modulus (GPa)	2.8	5
Elongation (%)	55	5.6

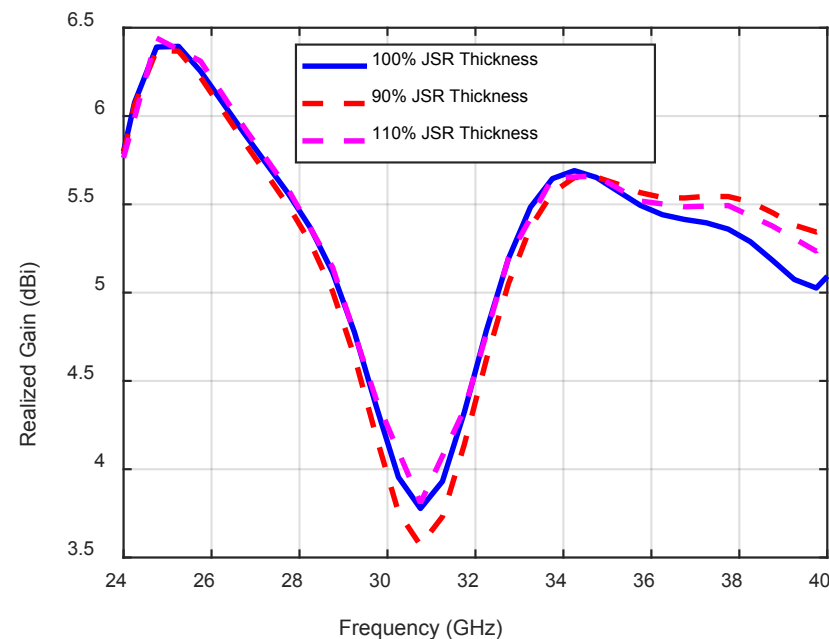
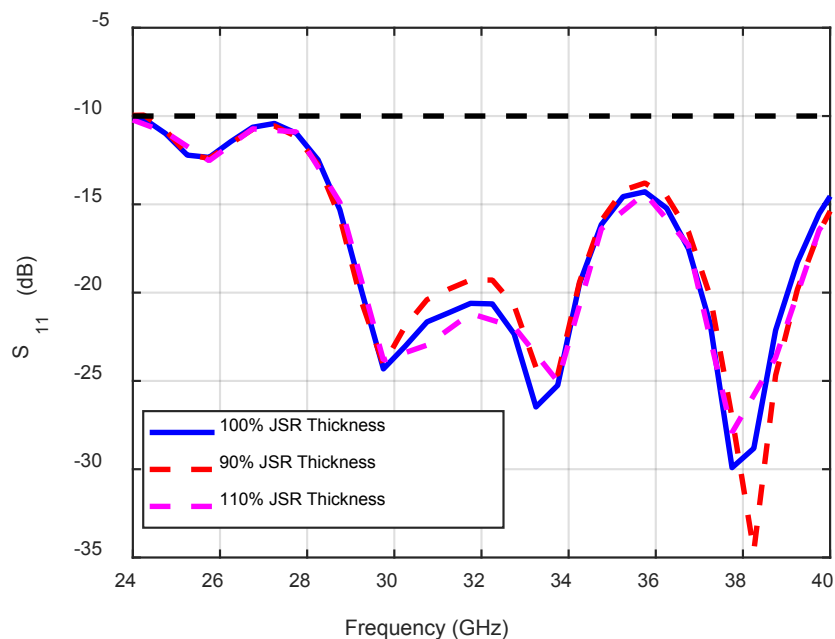




Results & Key Accomplishments

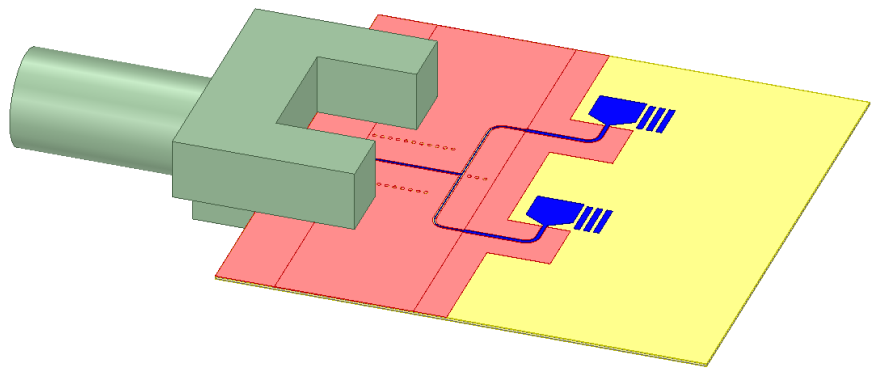


- Operation Band: 24 – 40 GHz
- $S_{11} < -10$ dB
- Realized gain > 3.8 dBi
- Good resist to thickness variation

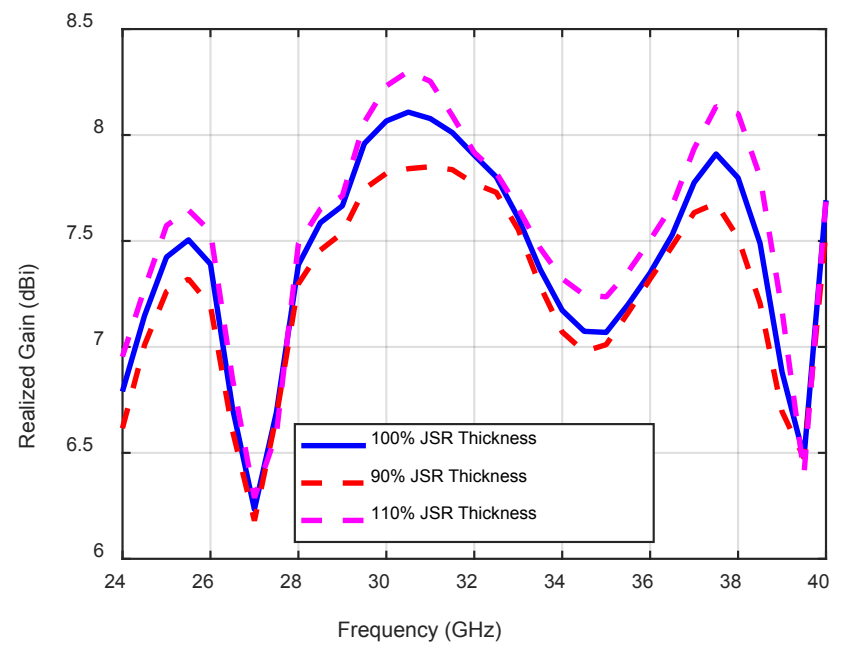
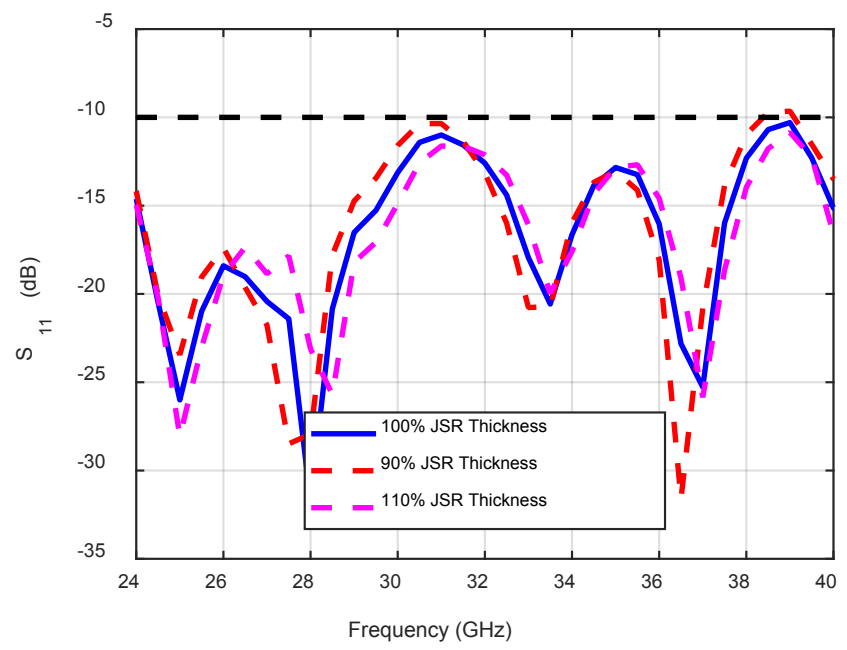




Results & Key Accomplishments



- Operation Band: 24 – 40 GHz
- $S_{11} < -10$ dB
- Realized gain > 6.2 dBi
- Good resist to thickness variation



Results & Key Accomplishments



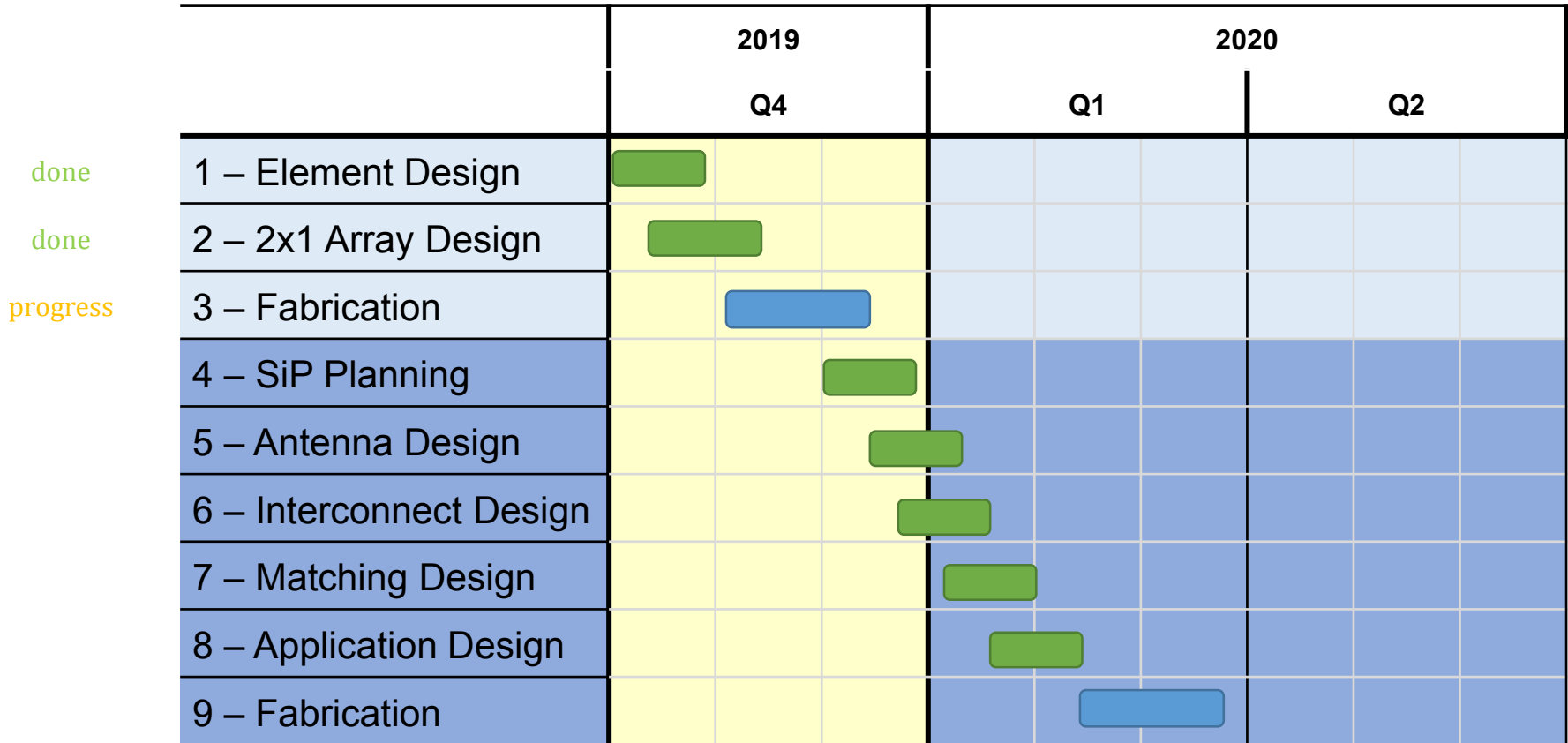
**Panel Design Figure
Coming Soon**

Comparison with Prior Art



			<h2>This work</h2>
Fabrication method	Laminate	LTCC	Glass
Band (GHz)	24	37.5 – 42	24 – 40
Bandwidth (GHz)	< 1	4.5	16
FBW (%)	3	12.5	49
Thickness (μm)	254	832	176
Realized Gain (dBi)	9.3	5	3.8
Size	$0.45 \lambda_0 \times 1.12 \lambda_0$	$0.48 \lambda_0 \times 0.63 \lambda_0$	$0.13 \lambda_0 \times 0.24 \lambda_0$

Schedule



Light blue: UWB 5G Array Design
 Dark blue: UWB 5G System Design
 Light Yellow: Current time window

[Green bar] Design
 [Blue bar] Fabrication

Summary



- Designed UWB and miniaturized Yagi antenna element
- Covered both 5G band simultaneously
- Consider effects of end launch connector and thickness variation
- Panel design for fabrication

Future Work

- Prototype fabrication and characterization
- UWB 5G modules utilized the designed antenna (array)